

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the PATENT APPLICATION of:

Ong et al.

Application No.: 13/521,648

Confirmation No.: 2310

Filed: September 28, 2012

For: HIGH PRESSURE SEAL ADAPTER
FOR SPLITTER CONDUCTOR HOUSING TO
WELLHEAD CONNECTION

Group: 3676

Examiner: Yong-Suk Ro

Our File: SFPASS-PT001

Date: September 5, 2013

**COMMUNICATION REGARDING SUPPLEMENTAL
APPLICATION DATA SHEET**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant respectfully submits herewith a Supplemental Application Data Sheet. The Supplemental Application Data Sheet is being filed to update the address of the Assignee, Aker Solutions Singapore Pte. Ltd., as well as updating application identifier information.

No new matter has been added.

Respectfully submitted,

Ong et al.

By /Stephen B. Schott/
Stephen B. Schott
Registration No. 51,294
(215) 568-6400

Volpe and Koenig, P.C.
United Plaza
30 South 17th Street
Philadelphia, PA 19103-4009

SBS/say

Enclosure

-Supplemental Application Data Sheet (4 pages)